

Carbon Fiber Polypropylene Filament

SKU: FL900PP-CF

Xtellar Carbon Fiber PP Filament is an engineering-grade composite made from 100% recycled carbon fiber (CF) and is designed to provide robust mechanical performance while maintaining a high degree of printability for complex structures. This fiber reinforced filament provides engineering level performance without compromising any of PP's inherent properties which include light weight, water resistance (no drying needed), chemical resistance, and impact resistance.

Recommended Print Settings

Parameter	Units	Range
Extruder Temperature	°C	240 - 260
Nozzle Size (Material)	mm	≥0.6 (Hardened Nozzle)
Recommended Bed Temperature / Substrate ^a	°C / Type	80 / PP bed adhesion solution stick (water soluble)
Alternate Bed Temperature / Substrate ^b	°C / Type	20-40 / Multi-purpose adhesive spray
Printing Speed (First Layer)	mm/s	35 - 65 (60% speed)
Fan Speed	%	50 - 100
Extrusion Multiplier	–	0.90 – 1.10
Overlap Percentage	%	20 – 40
Brim	Layers	0 - 5
Support/Raft Air Gap	mm	0.2 or single layer thickness

Printed Part Properties

Parameter	Method	Units	Value	
Density	D 792	g/cm ³	0.91	
Hardness	D 2240	Shore D	63	
Ultimate Tensile Strength*	D 638	MPa	41	
Tensile Elongation at Break*	D 638	%	1.3	
Young's Modulus *	D 638	MPa	6380	
Flexural Modulus – Chord Modulus *	D 790	MPa	4512	
Charpy Impact Strength at 23°C*	ISO 179	kJ/m ²	11.6	
Drop Impact Puncture Energy at 2.73 m/s, 3 mm	23°C	D 3763	J	5.2
	0°C,	D 3763	J	6.2
	-20°C	D 3763	J	5.4
Deflection Temperature at 0.455 MPa, 12.7mm	D 648	°C	158	
Vicat Softening Temperature at 10 N	D 1525	°C	150	

Notes

1. Recommended process conditions and printed part properties may be changed at any moment without previous communication from Xtellar
2. Printed part properties obtained using test specimens printed in X-Y direction under the following conditions: printing temperature 230°C, bed temperature 20°C (90°C first layer) , print speed 20 mm/s, 100% of lines infill, 0 perimeter layers, 0.15 mm layer height, 0.4 mm brass nozzle.
3. Traditional bed adhesive solutions used for PLA & ABS (such as blue tape or hair spray) will not properly adhere PP, PE, or EVA to the build plate.
4. This resin does not contain the substance Bisphenol A (BPA, CAS: 80-05-7) in its composition.

5. For information on about safety, handling, individual protection, first aids and waste disposal, please see SDS. In case of questions regarding utilization or regulatory information, please contact our technical assistance area.